

## MOS Field Effect Transistor

## 2SJ213

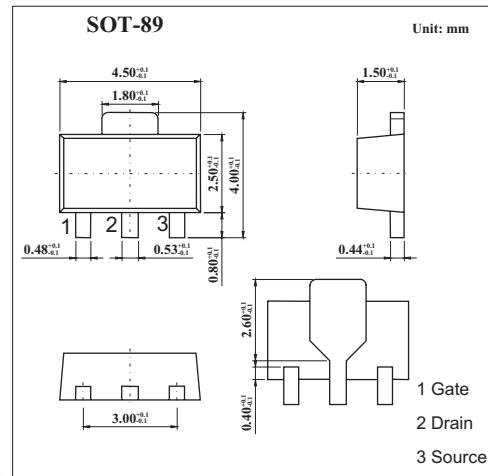
## ■ Features

- Directly driven by Ics having a 5V power supply.

- Has low on-state resistance

$R_{DS(on)} = 5.0 \Omega$  MAX. @  $V_{GS} = -4.0V, I_D = -0.3A$

$R_{DS(on)} = 4.2 \Omega$  MAX. @  $V_{GS} = -1.0V, I_D = -0.3A$

■ Absolute Maximum Ratings  $T_a = 25^\circ C$ 

Parameter	Symbol	Rating	Unit
Drain to source voltage $V_{GS}=0$	$V_{DSS}$	-100	V
Gate to source voltage $V_{DS}=0$	$V_{GSS}$	$\pm 20$	V
Drain current (DC)	$I_D$	$\pm 500$	mA
Drain current(pulse) *	$I_D$	$\pm 1.0$	A
Power dissipation	$P_D$	2.0	W
Channel temperature	$T_{ch}$	150	$^\circ C$
Storage temperature	$T_{stg}$	-55 to +150	$^\circ C$

\*  $PW \leq 10$  ms;  $d \geq 50\%$ .

■ Electrical Characteristics  $T_a = 25^\circ C$ 

Parameter	Symbol	Testconditions	Min	Typ	Max	Unit
Drain cut-off current	$I_{DS(on)}$	$V_{DS} = -100V, V_{GS} = 0$			-10	$\mu A$
Gate leakage current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0$			$\pm 10$	$\mu A$
Gate cut-off voltage	$V_{GS(off)}$	$V_{DS} = -10V, I_D = -1mA$	-1.0	-2.1	-3.0	V
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = -5.0V, I_D = -300mA$	0.4	0.5		s
Drain to source on-state resistance	$R_{DS(on)}$	$V_{GS} = -4.0V, I_D = -300mA$		2.5	5.0	$\Omega$
		$V_{GS} = -10V, I_D = -300mA$		1.8	4.2	$\Omega$
Input capacitance	$C_{iss}$	$V_{DS} = -10V, V_{GS} = 0, f = 1MHz$		165		pF
Output capacitance	$C_{oss}$			75		pF
Reverse transfer capacitance	$C_{rss}$			13		pF
Turn-on delay time	$t_{d(on)}$	$V_{GS(on)} = -4V, R_G = 10\Omega, V_{DD} = -5V, I_D = -0.3A, R_L = 1.5\Omega$		110		ns
Rise time	$t_r$			320		ns
Turn-off delay time	$t_{d(off)}$			100		ns
Fall time	$t_f$			130		ns

## ■ Marking

Marking	PP
---------	----